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AME	Docket No. 291958161US1				
Application No.		Filing Date		Examiner	Art Unit
09/893,316-Conf. #2811		June 26, 2001		G. R. Koch	1734
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Attorney Reg. N	No.: 38,264				
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Docket No.: 291958161US1 Client Ref No. P01-0046US2

(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Reardon et al.

Application No.: 09/893,316

Confirmation No.: 2811

Filed: June 26, 2001

Art Unit: 1734

For: SEMICONDUCTOR PROCESSING SPRAY

Examiner: G. R. Koch

COATING APPARATUS

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated 30 December 2005 please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 11 of this paper.